

74LVC1G3157

2-channel analog multiplexer/demultiplexer

Rev. 02 — 18 September 2007

Product data sheet

1. General description

The 74LVC1G3157 is a low-power, low-voltage, high-speed Si-gate CMOS device.

The 74LVC1G3157 provides one analog multiplexer/demultiplexer with one digital select input (S), two independent inputs/outputs (Y0, Y1) and a common input/output (Z).

Schmitt trigger action at the select input makes the circuit tolerant of slower input rise and fall times across the entire V_{CC} range from 1.65 V to 5.5 V.

2. Features

- Wide supply voltage range from 1.65 V to 5.5 V
- Very low ON resistance:
 - ◆ 7.5 Ω (typical) at $V_{CC} = 2.7$ V
 - ◆ 6.5 Ω (typical) at $V_{CC} = 3.3$ V
 - ◆ 6 Ω (typical) at $V_{CC} = 5$ V
- Switch current capability of 32 mA
- Break-before-make switching
- High noise immunity
- CMOS low power consumption
- TTL interface compatibility at 3.3 V
- Latch-up performance meets requirements of JESD 78 Class I
- ESD protection:
 - ◆ HBM JESD22-A114E exceeds 2000 V
 - ◆ MM JESD22-A115-A exceeds 200 V
- Control input accepts voltages up to 5.5 V
- Multiple package options
- Specified from -40 °C to $+85$ °C and from -40 °C to $+125$ °C

3. Ordering information

Table 1. Ordering information

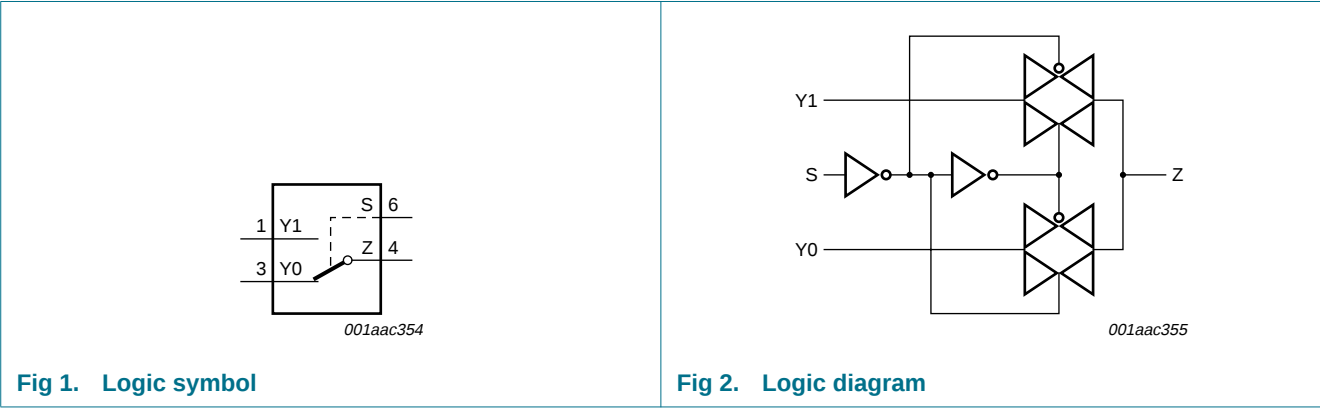
Type number	Package			
	Temperature range	Name	Description	Version
74LVC1G3157GW	−40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363
74LVC1G3157GV	−40 °C to +125 °C	SC-74	plastic surface-mounted package (TSOP6); 6 leads	SOT457
74LVC1G3157GM	−40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1.45 × 0.5 mm	SOT886
74LVC1G3157GF	−40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1 × 0.5 mm	SOT891

4. Marking

Table 2. Marking

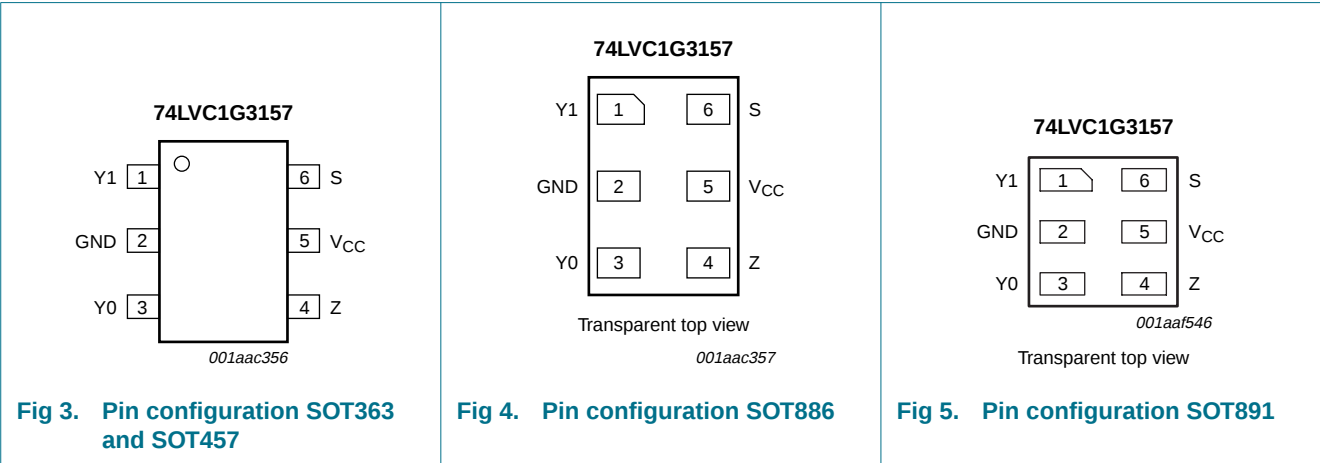
Type number	Marking code
74LVC1G3157GW	YJ
74LVC1G3157GV	YJ
74LVC1G3157GM	YJ
74LVC1G3157GF	YJ

5. Functional diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
Y1	1	independent input or output
GND	2	ground (0 V)
Y0	3	independent input or output
Z	4	common output or input
V _{CC}	5	supply voltage
S	6	select input

7. Functional description

Table 4. Function table^[1]

Input S	Channel on
L	Y0
H	Y1

[1] H = HIGH voltage level;
L = LOW voltage level.

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+6.5	V
V_I	input voltage		[1] -0.5	+6.5	V
I_{IK}	input clamping current	$V_I < -0.5\text{ V}$ or $V_I > V_{CC} + 0.5\text{ V}$	-50	-	mA
I_{SK}	switch clamping current	$V_I < -0.5\text{ V}$ or $V_I > V_{CC} + 0.5\text{ V}$	-	±50	mA
V_{SW}	switch voltage	enable and disable mode	[2] -0.5	$V_{CC} + 0.5$	V
I_{SW}	switch current	$V_{SW} > -0.5\text{ V}$ or $V_{SW} < V_{CC} + 0.5\text{ V}$	-	±50	mA
I_{CC}	supply current		-	100	mA
I_{GND}	ground current		-100	-	mA
T_{stg}	storage temperature		-65	+150	°C
P_{tot}	total power dissipation	$T_{amb} = -40\text{ °C}$ to $+125\text{ °C}$	[3] -	250	mW

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed.

[3] For SC-88 and SC-74 packages: above 87.5 °C the value of P_{tot} derates linearly with 4.0 mW/K.
For XSON6 packages: above 45 °C the value of P_{tot} derates linearly with 2.4 mW/K.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CC}	supply voltage		1.65	-	5.5	V
V_I	input voltage		0	-	5.5	V
V_{SW}	switch voltage	enable and disable mode	[1] 0	-	V_{CC}	V
T_{amb}	ambient temperature		-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 1.65\text{ V}$ to 2.7 V	[2] -	-	20	ns/V
		$V_{CC} = 2.7\text{ V}$ to 5.5 V	[2] -	-	10	ns/V

[1] To avoid sinking GND current from terminal Z when switch current flows in terminal Yn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no GND current will flow from terminal Yn. In this case, there is no limit for the voltage drop across the switch.

[2] Applies to control signal levels.

10. Static characteristics

Table 7. Static characteristics

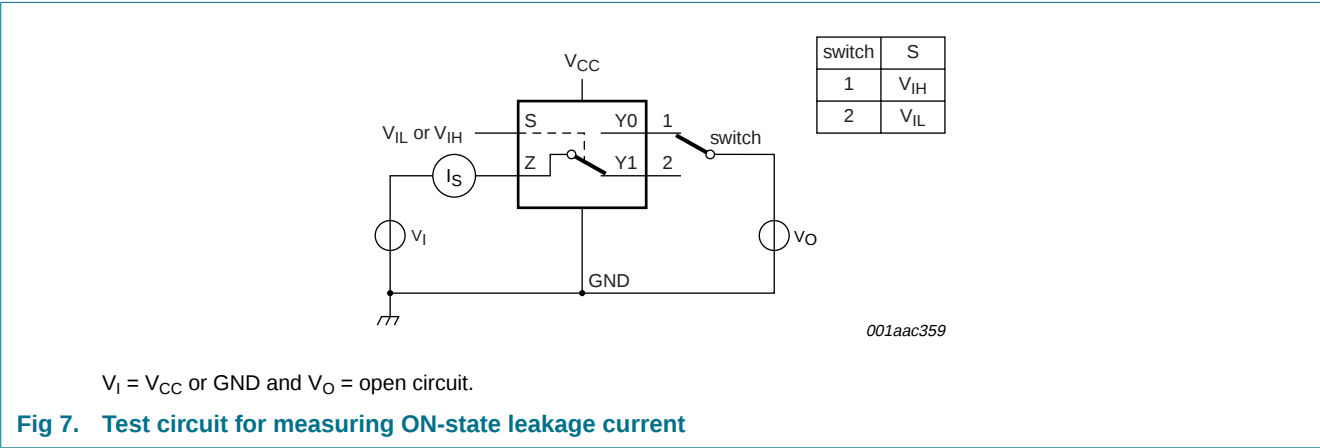
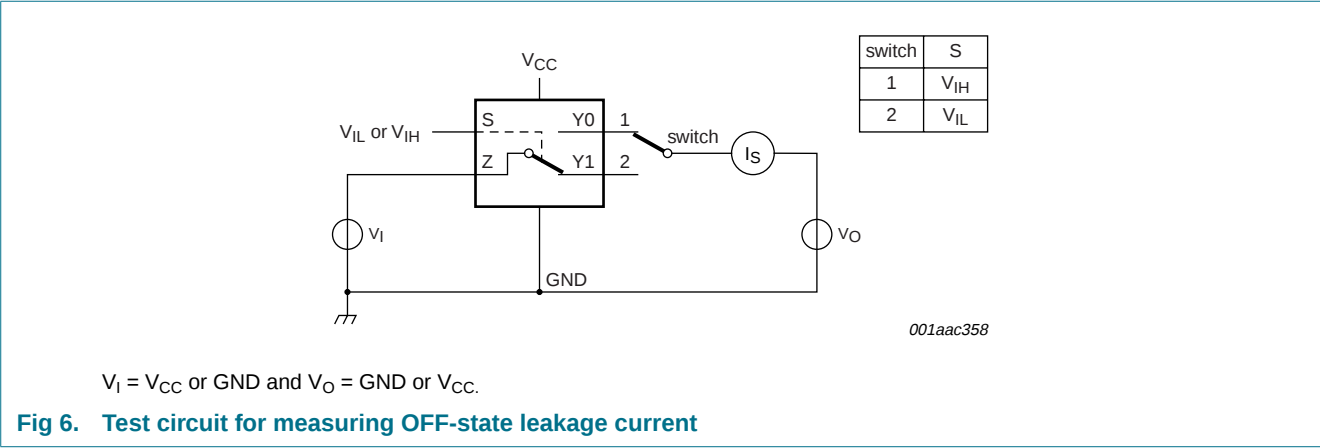
At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions	–40 °C to +85 °C			–40 °C to +125 °C		Unit	
			Min	Typ ^[1]	Max	Min	Max		
V _{IH}	HIGH-level input voltage	V _{CC} = 1.65 V to 1.95 V	0.65V _{CC}	-	-	0.65V _{CC}	-	V	
		V _{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V	
		V _{CC} = 3 V to 3.6 V	2.0	-	-	2.0	-	V	
		V _{CC} = 4.5 V to 5.5 V	0.7V _{CC}	-	-	0.7V _{CC}	-	V	
V _{IL}	LOW-level input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	0.35V _{CC}	-	0.35V _{CC}	V	
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V	
		V _{CC} = 3 V to 3.6 V	-	-	0.8	-	0.8	V	
		V _{CC} = 4.5 V to 5.5 V	-	-	0.3V _{CC}	-	0.3V _{CC}	V	
I _I	input leakage current	pin S; V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	[2]	-	±0.1	±2	-	±10	μA
I _{S(OFF)}	OFF-state leakage current	V _I = V _{IH} or V _{IL} ; V _{CC} = 5.5 V; see Figure 6	[2]	-	±0.1	±5	-	±20	μA
I _{S(ON)}	ON-state leakage current	V _I = V _{IH} or V _{IL} ; V _{CC} = 5.5 V; see Figure 7	[2]	-	±0.1	±5	-	±20	μA
I _{CC}	supply current	V _I = 5.5 V or GND; V _{SW} = GND or V _{CC} ; I _O = 0 A; V _{CC} = 1.65 V to 5.5 V	[2]	-	0.1	10	-	40	μA
ΔI _{CC}	additional supply current	pin S; V _I = V _{CC} – 0.6 V; I _O = 0 A; V _{CC} = 5.5 V; V _{SW} = GND or V _{CC}	[2]	-	5	500	-	5000	μA
C _I	input capacitance		-	2.5	-	-	-	-	pF
C _{S(OFF)}	OFF-state capacitance		-	6.0	-	-	-	-	pF
C _{S(ON)}	ON-state capacitance		-	18	-	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C.

[2] These typical values are measured at V_{CC} = 3.3 V

10.1 Test circuits



10.2 ON resistance

Table 8. ON resistance

At recommended operating conditions; voltages are referenced to GND (ground 0 V); for graphs see [Figure 9](#) to [Figure 14](#).

Symbol	Parameter	Conditions	−40 °C to +85 °C			−40 °C to +125 °C		Unit
			Min	Typ ^[1]	Max	Min	Max	
RON(peak)	ON resistance (peak)	$V_I =$ GND to V_{CC} ; see Figure 8						
		$I_{SW} = 4$ mA; $V_{CC} = 1.65$ V to 1.95 V	-	34.0	130	-	195	Ω
		$I_{SW} = 8$ mA; $V_{CC} = 2.3$ V to 2.7 V	-	12.0	30	-	45	Ω
		$I_{SW} = 12$ mA; $V_{CC} = 2.7$ V	-	10.4	25	-	38	Ω
		$I_{SW} = 24$ mA; $V_{CC} = 3$ V to 3.6 V	-	7.8	20	-	30	Ω
		$I_{SW} = 32$ mA; $V_{CC} = 4.5$ V to 5.5 V	-	6.2	15	-	23	Ω

Table 8. ON resistance ...continuedAt recommended operating conditions; voltages are referenced to GND (ground 0 V); for graphs see [Figure 9](#) to [Figure 14](#).

Symbol	Parameter	Conditions	–40 °C to +85 °C			–40 °C to +125 °C		Unit
			Min	Typ ^[1]	Max	Min	Max	
R _{ON(rail)}	ON resistance (rail)	V _I = GND; see Figure 8						
		I _{SW} = 4 mA; V _{CC} = 1.65 V to 1.95 V	-	8.2	18	-	27	Ω
		I _{SW} = 8 mA; V _{CC} = 2.3 V to 2.7 V	-	7.1	16	-	24	Ω
		I _{SW} = 12 mA; V _{CC} = 2.7 V	-	6.9	14	-	21	Ω
		I _{SW} = 24 mA; V _{CC} = 3 V to 3.6 V	-	6.5	12	-	18	Ω
		I _{SW} = 32 mA; V _{CC} = 4.5 V to 5.5 V	-	5.8	10	-	15	Ω
		V _I = V _{CC} ; see Figure 8						
		I _{SW} = 4 mA; V _{CC} = 1.65 V to 1.95 V	-	10.4	30	-	45	Ω
		I _{SW} = 8 mA; V _{CC} = 2.3 V to 2.7 V	-	7.6	20	-	30	Ω
		I _{SW} = 12 mA; V _{CC} = 2.7 V	-	7.0	18	-	27	Ω
		I _{SW} = 24 mA; V _{CC} = 3 V to 3.6 V	-	6.1	15	-	23	Ω
		I _{SW} = 32 mA; V _{CC} = 4.5 V to 5.5 V	-	4.9	10	-	15	Ω
R _{ON(flat)}	ON resistance (flatness)	V _I = GND to V _{CC} ^[2]						
		I _{SW} = 4 mA; V _{CC} = 1.65 V to 1.95 V	-	26.0	-	-	-	Ω
		I _{SW} = 8 mA; V _{CC} = 2.3 V to 2.7 V	-	5.0	-	-	-	Ω
		I _{SW} = 12 mA; V _{CC} = 2.7 V	-	3.5	-	-	-	Ω
		I _{SW} = 24 mA; V _{CC} = 3 V to 3.6 V	-	2.0	-	-	-	Ω
		I _{SW} = 32 mA; V _{CC} = 4.5 V to 5.5 V	-	1.5	-	-	-	Ω

[1] Typical values are measured at T_{amb} = 25 °C and nominal V_{CC}.[2] Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V_{CC} and temperature.

10.3 ON resistance test circuit and graphs

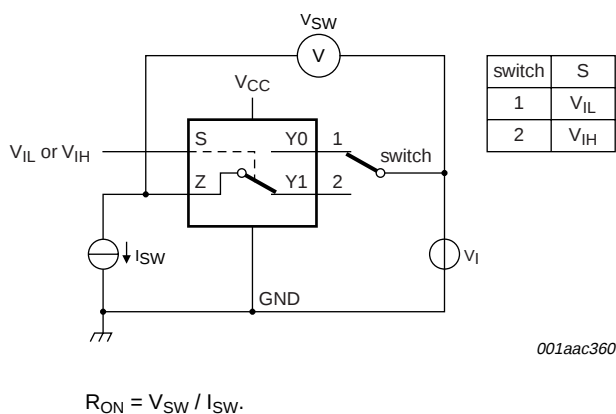


Fig 8. Test circuit for measuring ON resistance

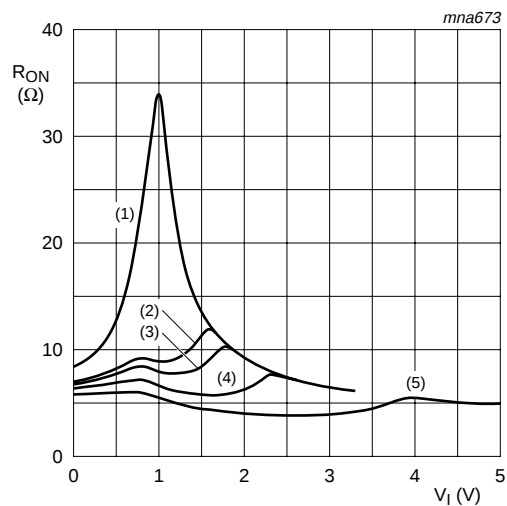
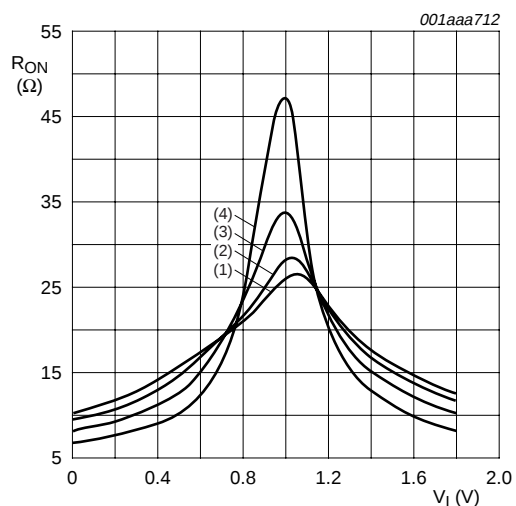
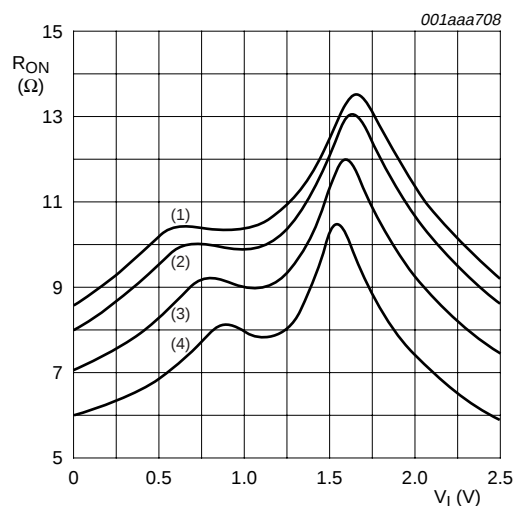


Fig 9. Typical ON resistance as a function of input voltage; $T_{amb} = 25^{\circ}\text{C}$



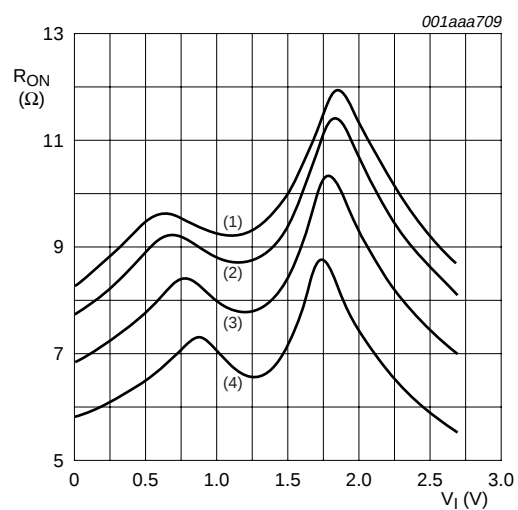
- (1) $T_{\text{amb}} = 125\text{ }^{\circ}\text{C}$.
- (2) $T_{\text{amb}} = 85\text{ }^{\circ}\text{C}$.
- (3) $T_{\text{amb}} = 25\text{ }^{\circ}\text{C}$.
- (4) $T_{\text{amb}} = -40\text{ }^{\circ}\text{C}$.

**Fig 10. ON resistance as a function of input voltage;
 $V_{CC} = 1.8\text{ V}$**



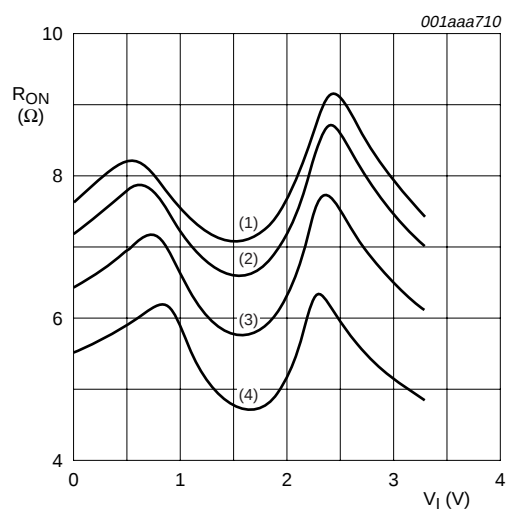
- (1) $T_{\text{amb}} = 125\text{ }^{\circ}\text{C}$.
- (2) $T_{\text{amb}} = 85\text{ }^{\circ}\text{C}$.
- (3) $T_{\text{amb}} = 25\text{ }^{\circ}\text{C}$.
- (4) $T_{\text{amb}} = -40\text{ }^{\circ}\text{C}$.

**Fig 11. ON resistance as a function of input voltage;
 $V_{CC} = 2.5\text{ V}$**



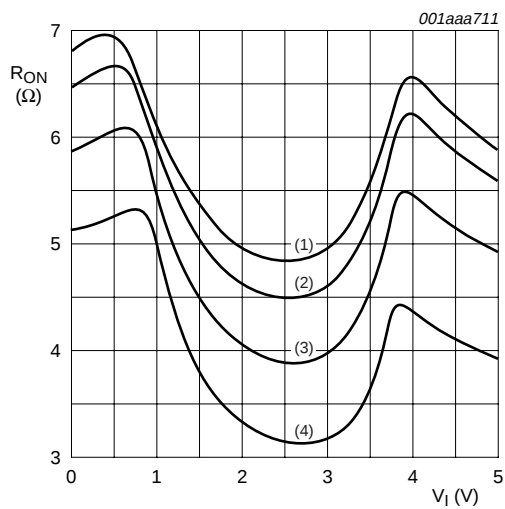
- (1) $T_{amb} = 125\text{ }^{\circ}\text{C}.$
- (2) $T_{amb} = 85\text{ }^{\circ}\text{C}.$
- (3) $T_{amb} = 25\text{ }^{\circ}\text{C}.$
- (4) $T_{amb} = -40\text{ }^{\circ}\text{C}.$

Fig 12. ON resistance as a function of input voltage;
 $V_{CC} = 2.7\text{ V}$



- (1) $T_{amb} = 125\text{ }^{\circ}\text{C}.$
- (2) $T_{amb} = 85\text{ }^{\circ}\text{C}.$
- (3) $T_{amb} = 25\text{ }^{\circ}\text{C}.$
- (4) $T_{amb} = -40\text{ }^{\circ}\text{C}.$

Fig 13. ON resistance as a function of input voltage;
 $V_{CC} = 3.3\text{ V}$



- (1) $T_{amb} = 125\text{ }^{\circ}\text{C}.$
- (2) $T_{amb} = 85\text{ }^{\circ}\text{C}.$
- (3) $T_{amb} = 25\text{ }^{\circ}\text{C}.$
- (4) $T_{amb} = -40\text{ }^{\circ}\text{C}.$

Fig 14. ON resistance as a function of input voltage; $V_{CC} = 5.0\text{ V}$

11. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see [Figure 18](#).

Symbol	Parameter	Conditions	–40 °C to +85 °C			–40 °C to +125 °C		Unit
			Min	Typ ^[1]	Max	Min	Max	
t_{pd}	propagation delay	Z to Yn or Yn to Z; see Figure 15 ^{[2][3]}						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	-	2	-	3.0	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	1.2	-	2.0	ns
		$V_{CC} = 2.7 \text{ V}$	-	-	1.0	-	1.5	ns
		$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$	-	-	0.8	-	1.5	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	-	-	0.6	-	1.0	ns
t_{en}	enable time	S to Yn; see Figure 16 ^[4]						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	1.0	8.7	14	1.0	14.0	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.0	5.3	7.5	1.0	7.5	ns
		$V_{CC} = 2.7 \text{ V}$	1.0	4.9	6.0	1.0	6.0	ns
		$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$	0.5	4.0	5.5	0.5	5.5	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	0.5	3.0	4.0	0.5	4.0	ns
t_{dis}	disable time	S to Yn; see Figure 16 ^[5]						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	2.5	6.0	8.5	2.5	8.5	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	2.0	4.4	6.0	2.0	6.0	ns
		$V_{CC} = 2.7 \text{ V}$	1.5	4.2	5.0	1.5	5.0	ns
		$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$	1.5	3.6	4.5	1.5	4.5	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	0.8	2.9	3.5	0.8	3.5	ns
t_{b-m}	break-before-make time	see Figure 17 ^[6]						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	0.5	-	-	0.5	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	0.5	-	-	0.5	-	ns
		$V_{CC} = 2.7 \text{ V}$	0.5	-	-	0.5	-	ns
		$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$	0.5	-	-	0.5	-	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	0.5	-	-	0.5	-	ns

[1] Typical values are measured at $T_{amb} = 25 \text{ °C}$ and nominal V_{CC} .

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] Propagation delay is the calculated RC time constant of the typical ON resistance of the switch and the specified capacitance when driven by an ideal voltage source (zero output impedance).

[4] t_{en} is the same as t_{PZH} and t_{PZL} .

[5] t_{dis} is the same as t_{PLZ} and t_{PHZ} .

[6] Break-before-make specified by design.

11.1 Waveforms and test circuits

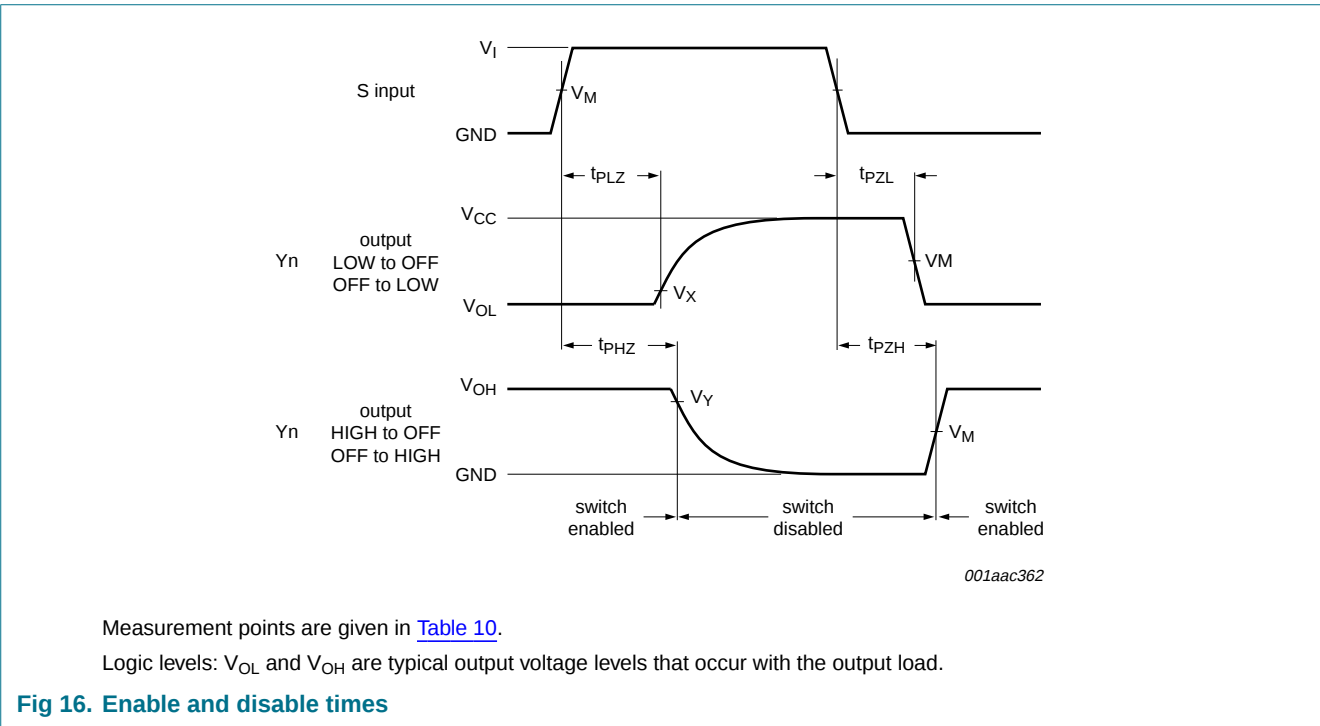
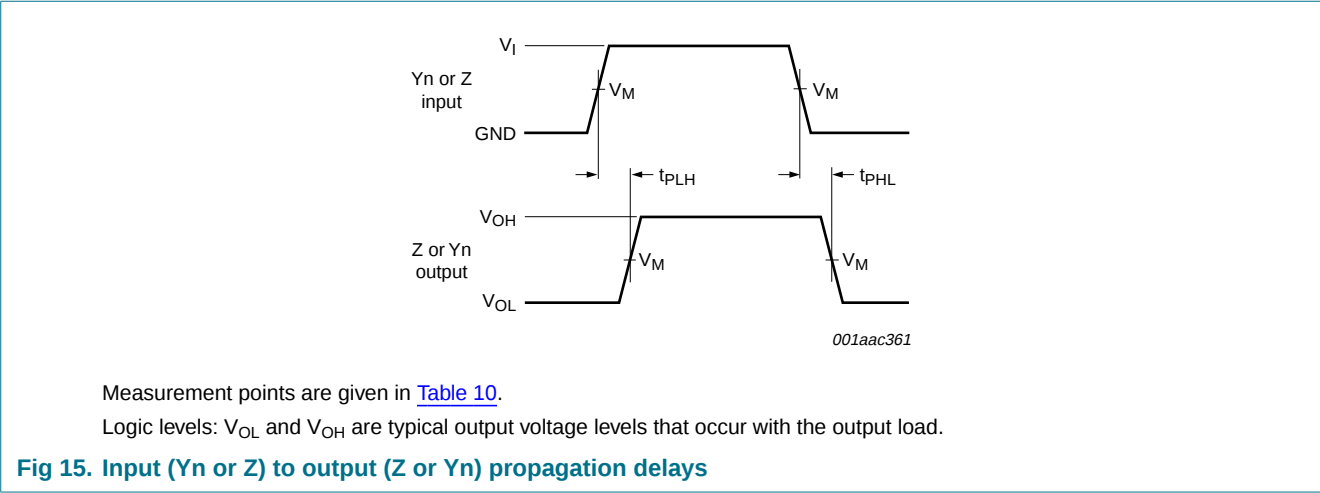
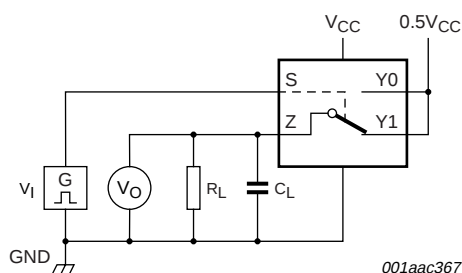
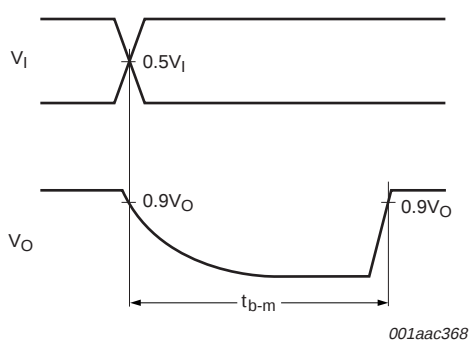


Table 10. Measurement points

Supply voltage	Input	Output		
V_{CC}	V_M	V_M	V_X	V_Y
1.65 V to 5.5 V	$0.5V_{CC}$	$0.5V_{CC}$	$V_{OL} + 0.3\text{ V}$	$V_{OH} - 0.3\text{ V}$

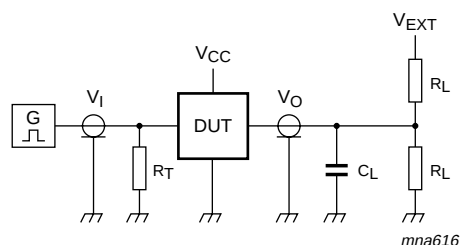


a. Test circuit



b. Input and output measurement points

Fig 17. Test circuit for measuring break-before-make timing



Test data is given in [Table 11](#).

Definitions test circuit:

R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

C_L = Load capacitance including jig and probe capacitance.

R_L = Load resistance.

V_{EXT} = External voltage for measuring switching times.

Fig 18. Load circuit for switching times

Table 11. Test data

Supply voltage	Input		Load		V _{EXT}		
V _{CC}	V _I	t _r , t _f	C _L	R _L	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
1.65 V to 1.95 V	V _{CC}	≤ 2.0 ns	50 pF	500 Ω	open	GND	2V _{CC}
2.3 V to 2.7 V	V _{CC}	≤ 2.0 ns	50 pF	500 Ω	open	GND	2V _{CC}
2.7 V	V _{CC}	≤ 2.5 ns	50 pF	500 Ω	open	GND	2V _{CC}
3 V to 3.6 V	V _{CC}	≤ 2.5 ns	50 pF	500 Ω	open	GND	2V _{CC}
4.5 V to 5.5 V	V _{CC}	≤ 2.5 ns	50 pF	500 Ω	open	GND	2V _{CC}

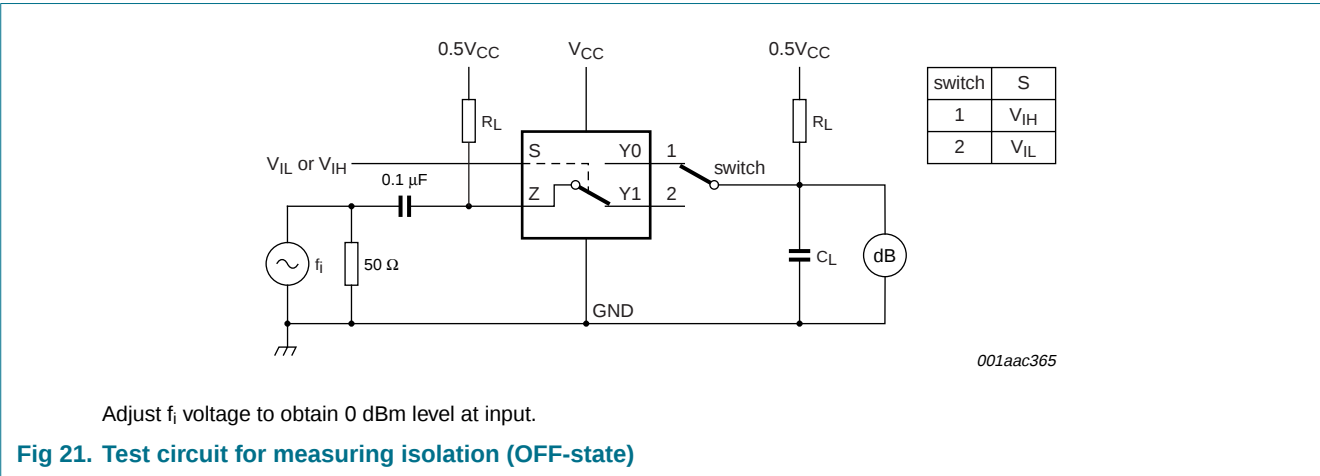
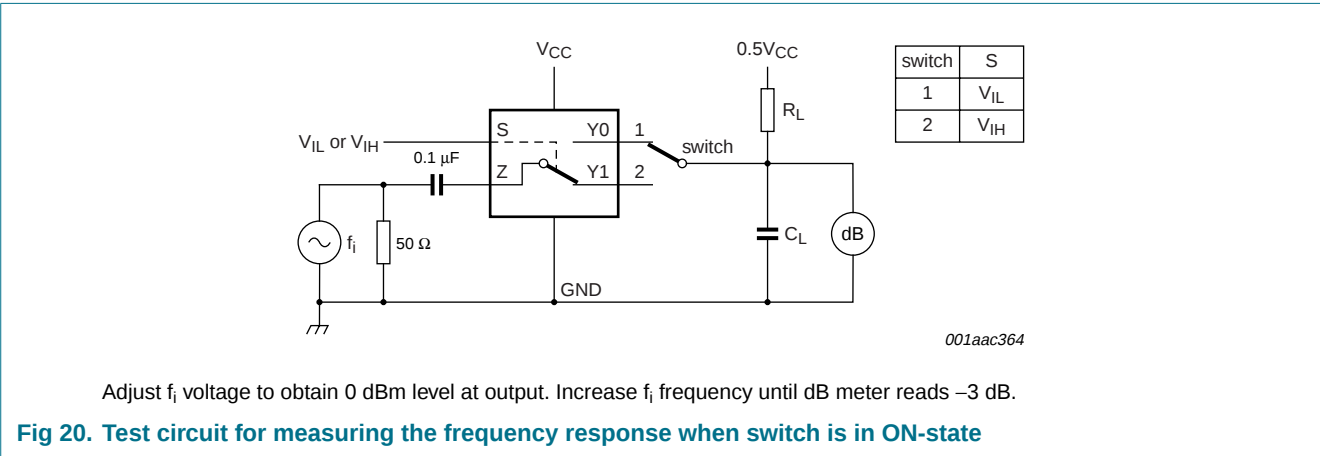
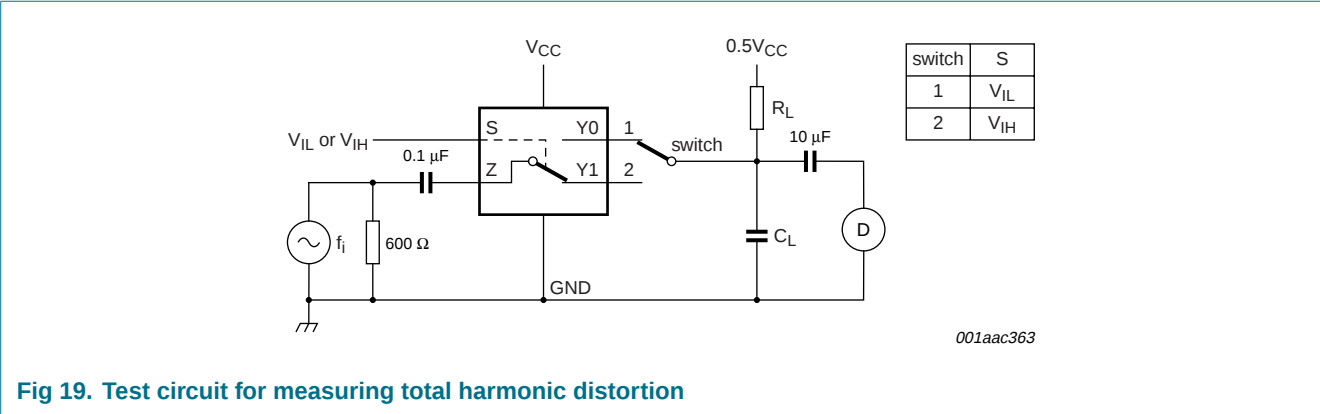
11.2 Additional dynamic characteristics

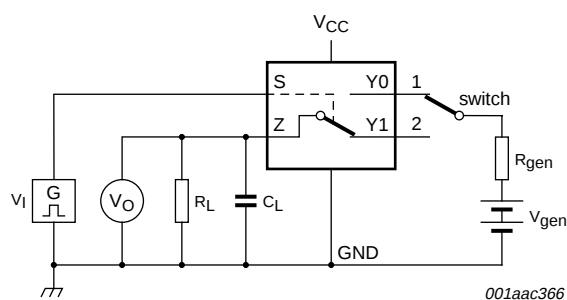
Table 12. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); T_{amb} = 25 °C.

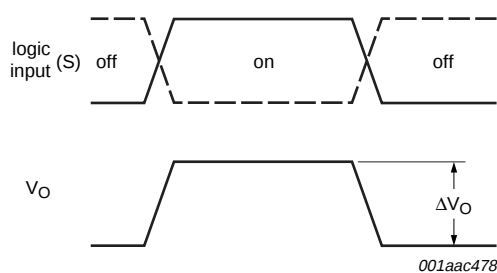
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
THD	total harmonic distortion	f _i = 600 Hz to 20 kHz; R _L = 600 Ω; C _L = 50 pF; V _I = 0.5 V (p-p); see Figure 19				
		V _{CC} = 1.65 V	-	0.260	-	%
		V _{CC} = 2.3 V	-	0.078	-	%
		V _{CC} = 3.0 V	-	0.078	-	%
		V _{CC} = 4.5 V	-	0.078	-	%
f _(-3dB)	-3 dB frequency response	R _L = 50 Ω; C _L = 5 pF; see Figure 20				
		V _{CC} = 1.65 V	-	200	-	MHz
		V _{CC} = 2.3 V	-	300	-	MHz
		V _{CC} = 3.0 V	-	300	-	MHz
		V _{CC} = 4.5 V	-	300	-	MHz
α _{iso}	isolation (OFF-state)	R _L = 50 Ω; C _L = 5 pF; f _i = 10 MHz; see Figure 21				
		V _{CC} = 1.65 V	-	-42	-	dB
		V _{CC} = 2.3 V	-	-42	-	dB
		V _{CC} = 3.0 V	-	-40	-	dB
		V _{CC} = 4.5 V	-	-40	-	dB
Q _{inj}	charge injection	C _L = 0.1 nF; V _{gen} = 0 V; R _{gen} = 0 Ω; f _i = 1 MHz; R _L = 1 MΩ; see Figure 22				
		V _{CC} = 1.8 V	-	3.3	-	pC
		V _{CC} = 2.5 V	-	4.1	-	pC
		V _{CC} = 3.3 V	-	5.0	-	pC
		V _{CC} = 4.5 V	-	6.4	-	pC
		V _{CC} = 5.5 V	-	7.5	-	pC

11.3 Test circuits





a. Test circuit



b. Input and output pulse definitions

$$Q_{inj} = \Delta V_O \times C_L$$

 ΔV_O = output voltage variation.

 R_{gen} = generator resistance.

 V_{gen} = generator voltage.

Fig 22. Test circuit for measuring charge injection

12. Package outline

Plastic surface-mounted package; 6 leads SOT363

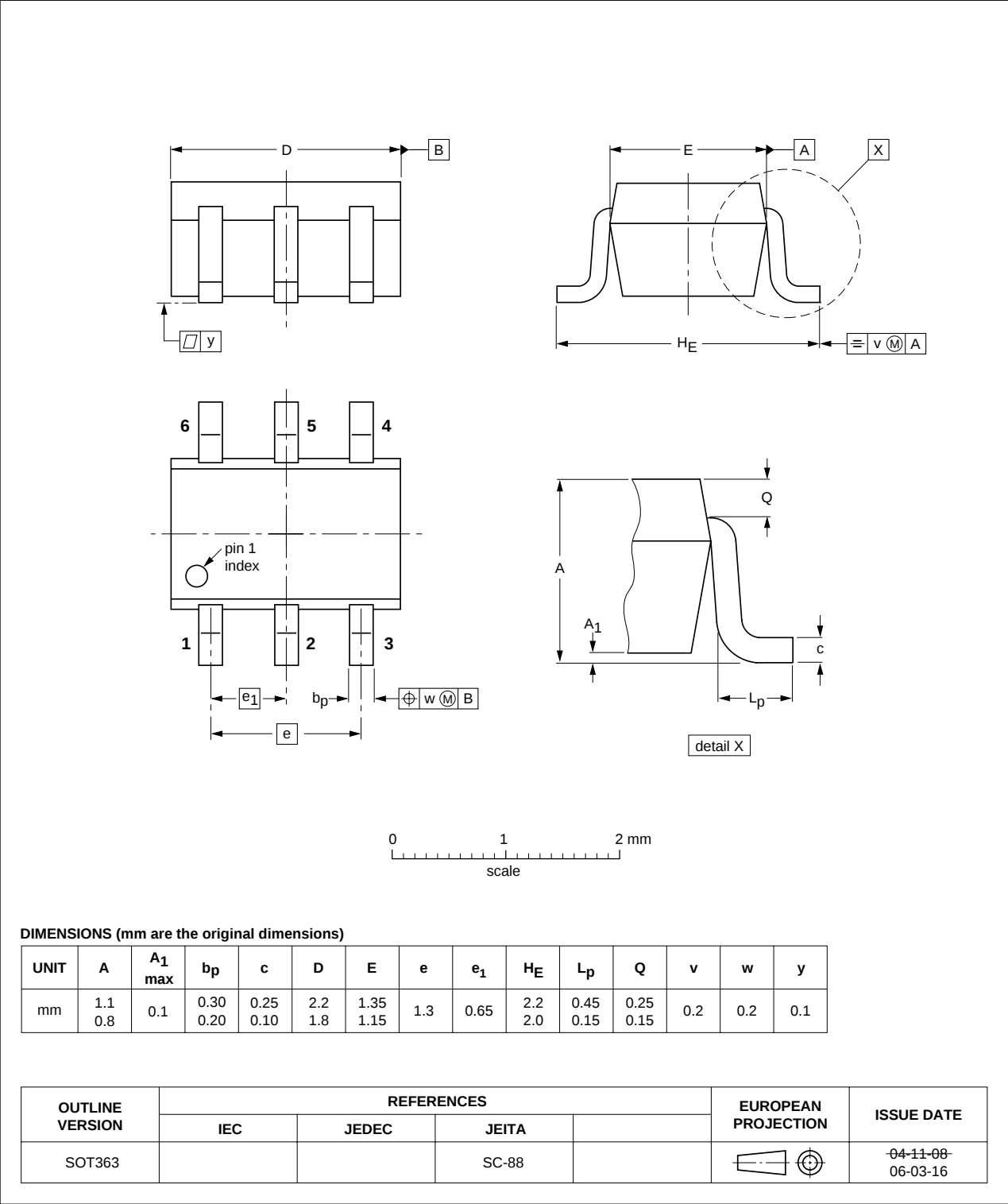


Fig 23. Package outline SOT363 (SC-88)

Plastic surface-mounted package (TSOP6); 6 leads

SOT457

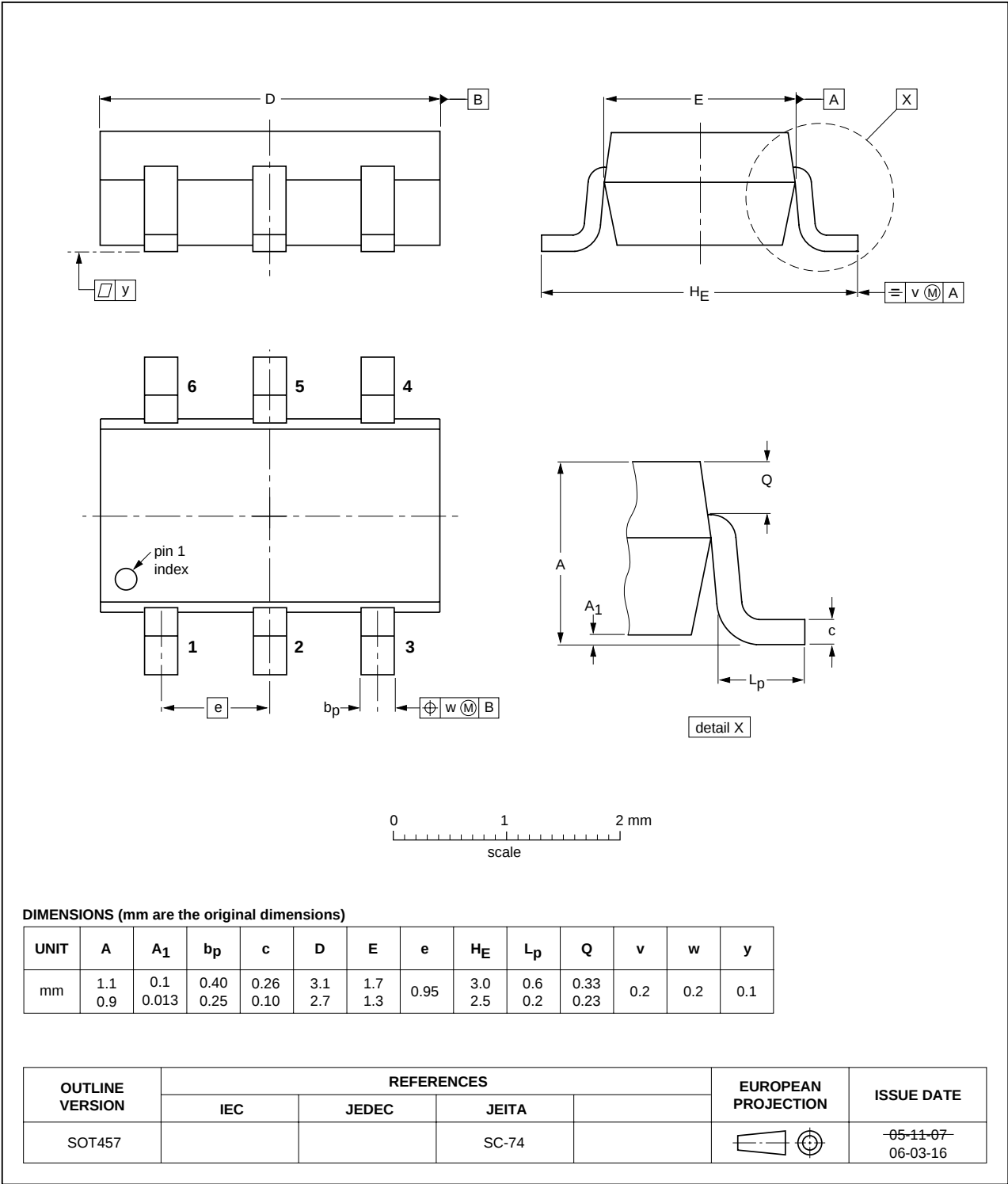


Fig 24. Package outline SOT457 (SC-74)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm

SOT886

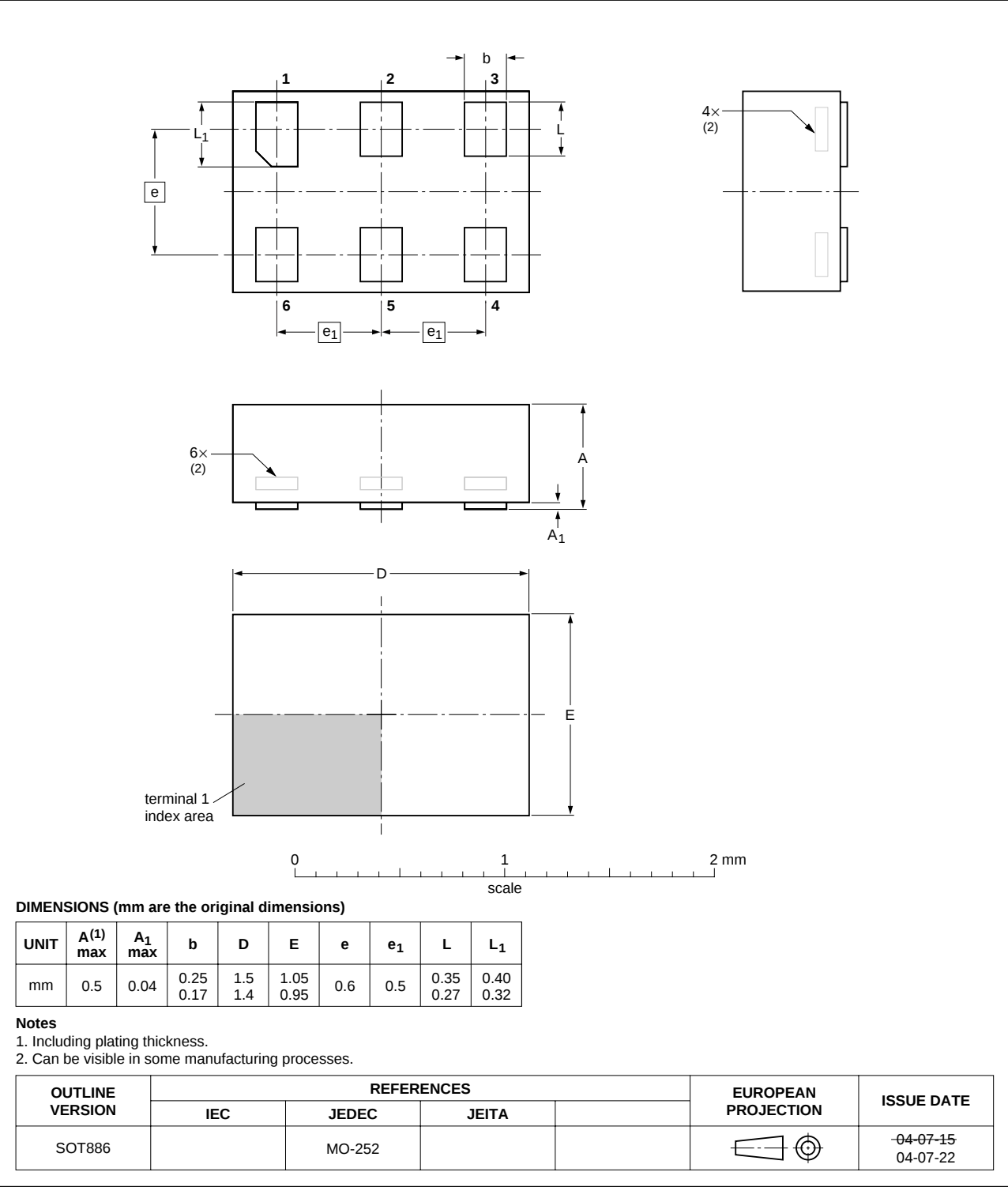


Fig 25. Package outline SOT886 (XSON6)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1 x 0.5 mm

SOT891

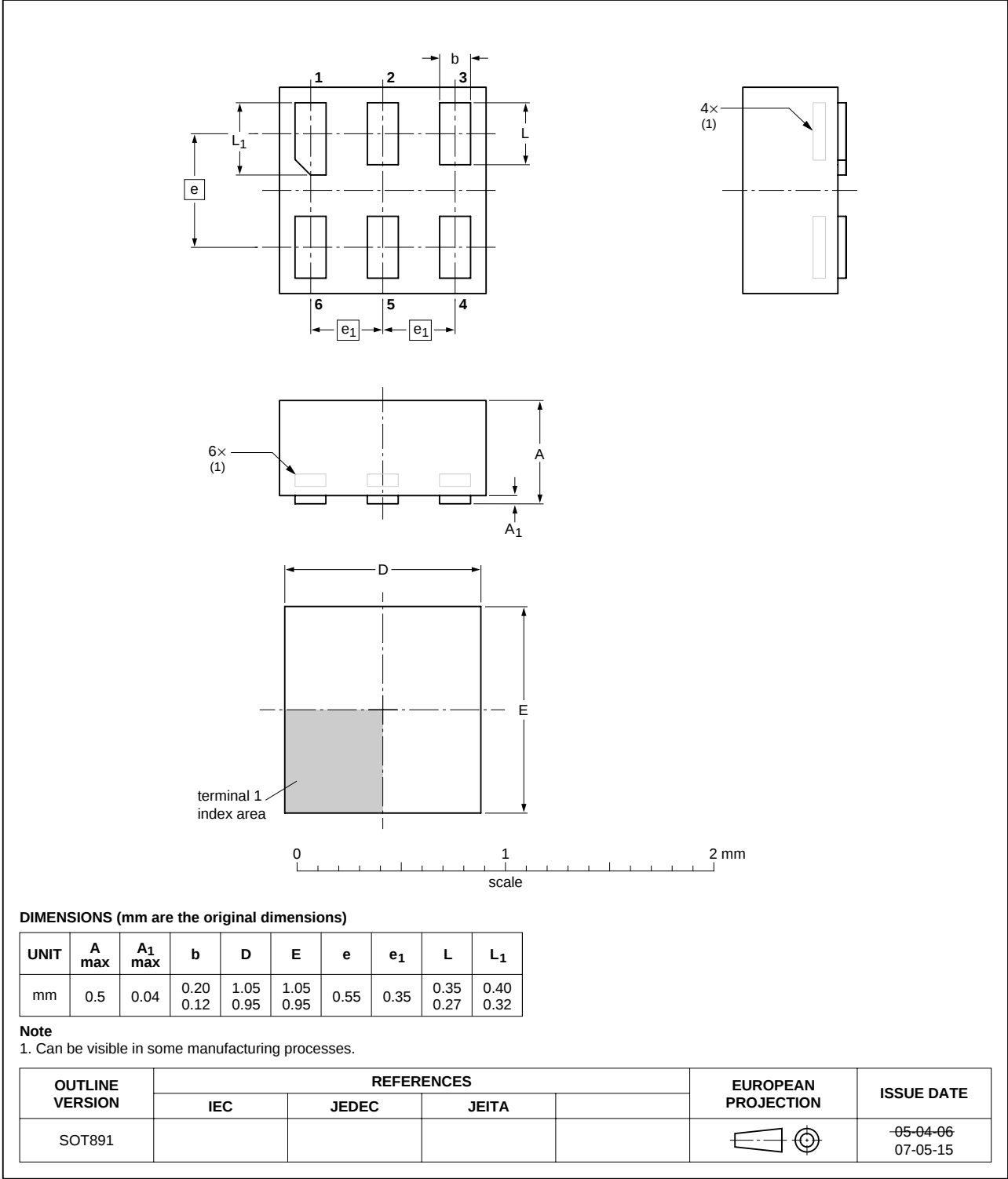


Fig 26. Package outline SOT891 (XSON6)

13. Abbreviations

Table 13. Abbreviations

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
TTL	Transistor-Transistor Logic
HBM	Human Body Model
ESD	ElectroStatic Discharge
MM	Machine Model
DUT	Device Under Test

14. Revision history

Table 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC1G3157_2	20070918	Product data sheet	-	74LVC1G3157_1
Modifications:	• The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. • Legal texts have been adapted to the new company name when appropriate. • Added type number 74LVC1G3157GF (XSON6 package). • Section 1 “General description”: Added: Schmitt trigger action at the enable input. • Section 2 “Features”: Added: Switch handling capability of 32 mA. • Section 8 “Limiting values”: Added: Derating factors of the applicable packages. • Section 10 “Static characteristics”: Changed: Maximum values of ON resistance (peak) parameters and graphics. Changed: Conditions for input leakage and supply current. Changed: Conditions for OFF-state and ON-state leakage current. • Section 11 “Dynamic characteristics”: Changed: Typical values of the charge injection.			
74LVC1G3157_1	20050207	Product data sheet	-	-

15. Legal information

15.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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Date of release: 18 September 2007

Document identifier: 74LVC1G3157_2